

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6391219

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WINGSHING CHAN	10/28/2020
LIHENG ZHOU	10/28/2020
XINYU ZHOU	10/28/2020
DEREK HO	11/02/2020
RECEIVING PARTY DATA	
Name:	CITY UNIVERSITY OF HONG KONG
Street Address:	83 TAT CHEE AVENUE
City:	KOWLOON
State/Country:	HONG KONG
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17092689
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	330-376-1242
Email:	mruhl@rennerkenner.com
Correspondent Name:	MARK L. WEBER RENNER, KENNER, GREIVE, BO
Address Line 1:	106 SOUTH MAIN STREET
Address Line 2:	HUNTINGTON TOWER, SUITE 400
Address Line 4:	AKRON, OHIO 44308
ATTORNEY DOCKET NUMBER:	MKC.P.529
NAME OF SUBMITTER:	MARK L. WEBER
SIGNATURE:	/marklweber/
DATE SIGNED:	11/09/2020
Total Attachments: 2	
source=2020-11-09 -- Executed Assignment#page1.tif	
source=2020-11-09 -- Executed Assignment#page2.tif	

Assignment

In Consideration of good and valuable consideration provided to the undersigned by the Assignee, City University of Hong Kong, 83 Tat Chee Avenue, Kowloon, Hong Kong, the receipt of which is hereby acknowledged, the undersigned by these presents hereby sold, assigned, transferred and set over unto the said Assignee the entire right, title and interest in and to the improvement in:

POWER AMPLIFIER


said invention being fully described and/or claimed in the application for Letters Patent of the United States of America in and for the United States and all foreign countries and all additional and divisional applications thereof, the same to be held and enjoyed by said Assignee, his successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patents therefore may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

And Said Assignee is Hereby Authorized to make application for and to receive Letters Patent for said invention in any of said countries of its election.

And By This Covenant The Undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said Assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patent which may be granted therefore in said Assignee, his successors, assigns or other legal representatives and upon the request and at the expense of said Assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of said Letters Patents to be granted therefore, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein without further compensation, but at the expense of said Assignee, his successors, assigns or other legal representatives.

And The Commissioner of Patents is Hereby Authorized and Requested to issue any and all Letters Patents of the United States for said invention, to said Assignee.

Signed and sealed:



CHAN, Wingshing

28 October 2020

Date

ZHOU Liheng 周礼恒

ZHOU, Liheng

28/10/2020

Date

ZHOU Xinyu 周新宇

ZHOU, Xinyu

28/10/2020

Date

HO, Derek

Date

838

Assignment

In Consideration of good and valuable consideration provided to the undersigned by the Assignee, City University of Hong Kong, 83 Tat Chee Avenue, Kowloon, Hong Kong, the receipt of which is hereby acknowledged, the undersigned by these presents hereby sold, assigned, transferred and set over unto the said Assignee the entire right, title and interest in and to the improvement in:

POWER AMPLIFIER

said invention being fully described and/or claimed in the application for Letters Patent of the United States of America in and for the United States and all foreign countries and all additional and divisional applications thereof, the same to be held and enjoyed by said Assignee, his successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patents therefore may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

And Said Assignee is Hereby Authorized to make application for and to receive Letters Patent for said invention in any of said countries of its election.

And By This Covenant The Undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said Assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patent which may be granted therefore in said Assignee, his successors, assigns or other legal representatives and upon the request and at the expense of said Assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of said Letters Patents to be granted therefore, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein without further compensation, but at the expense of said Assignee, his successors, assigns or other legal representatives.

And The Commissioner of Patents is Hereby Authorized and Requested to issue any and all Letters Patents of the United States for said invention, to said Assignee.

Signed and sealed:

.....
CHAN, Wingshing

.....
Date

.....
ZHOU, Liheng

.....
Date

.....
ZHOU, Xinyu

.....
Date

.....
HO, Derek

.....
Date

Nov 2, 2020